

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	ELECTRICAL PACKAGE STRUCTURE INCLUDING CHIP WITH POLYMER THEREON								
Application Number :									
Date :									
First Named Applicant: Mr. Kai-Kuang Ho									
Confirmation Number:									
Attorney Docket Number: 13365-US-PA									
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<table border="1" style="width: 100%; border-collapse: collapse;"><tr><td style="width: 50%; padding: 2px;">Submitted By:</td><td style="width: 50%; padding: 2px;">Elec. Sign.</td></tr><tr><td style="padding: 2px;">Dr. Belinda Lee Registered Number: 46,863</td><td style="padding: 2px; vertical-align: top;">/Belinda Lee/</td></tr></table>		Submitted By:	Elec. Sign.	Dr. Belinda Lee Registered Number: 46,863	/Belinda Lee/	<table border="1" style="width: 100%; border-collapse: collapse;"><tr><td style="width: 50%; padding: 2px;">Sign. Capacity</td><td style="width: 50%; padding: 2px;">Agent</td></tr></table>		Sign. Capacity	Agent
Submitted By:	Elec. Sign.								
Dr. Belinda Lee Registered Number: 46,863	/Belinda Lee/								
Sign. Capacity	Agent								

Documents being submitted:	Files
us-assignment	13365-usassn.xml us-assignment.xsl us-assignment.dtd 13365assignment1.tif 13365assignment2.tif
us-request	13365-usrequ.xml us-request.dtd us-request.xsl
us-fee-sheet	13365-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
application-body	13365usf.xml application-body.dtd Image1.tif Image2.tif Image3.tif Image4.tif Image5.tif isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isogrk1.ent isogrk2.ent isogrk3.ent isogrk4.ent isolat1.ent isolat2.ent isomfrk.ent isomopf.ent isomscr.ent isonum.ent isopub.ent isotech.ent mathml2.dtd mathml2-qname-1.mod mmlalias.ent mmlextra.ent soextblk.dtd us-application-body.xsl wipo.ent
application-body-pdf-wrap	13365usf-pdf-wrap.xml
abstract-pdf	13365usf-abst.pdf

claims-pdf	13365usf-clms.pdf
description-pdf	13365usf-desc.pdf
drawings-pdf	13365usf-draw.pdf
us-declaration	13365declaration1.tif
us-declaration	13365declaration2.tif

Comments

Please be kindly advised that the indicated fee of this EFS application is intended to be paid by credit card. However, in the event that the payment through credit card is unsuccessful, the Commissioner is authorized to charge the required fee in connection with this application to Deposit Account No. 50-2620(Order No. 13365-US-PA). Deposit Account Name: Jianq Chyun Intellectual Property Office, Authorized User Name: Belinda Lee, E-mail: Belinda@jcipgroup.com.tw; usa@jcipgroup.com.tw